SPEC. NO.: PS-50	022-XXXXX-XXX	REVISION: A
PRODUCT NAME:	0.5mm PITCH BTB SMT S/T	D/R CONNECTOR
PRODUCT NO:	50022 Series	
PRODUCT NO:	50022 Series	
PRODUCT NO: PREPARED:	50022 Series  CHECKED:	APPROVED:
		APPROVED:
		APPROVED:  DATE: 2014/01/18
PREPARED:  DATE:	CHECKED:  DATE:	DATE:

# Aces P/N: 50022 series TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR RELEASE DATE: 2014/01/18 REVISION: A ECN No: ECN-1401255 PAGE: **2** OF **9** 1 2 3 APPLICABLE DOCUMENTS ...... 4 4 REQUIREMENTS ...... 4 5 PERFORMANCE ...... 5 INFRARED REFLOW CONDITION...... 8 6 7

Revision History       Rev.     ECN #     Revision Description     Prepared     Date       O     ECN-1305063     NEW SPEC     XIAOXIONG     2013/05/0	Revision History         Revision Description         Prepared         Date           0         ECN-1305063         NEW SPEC         XIAOXIONG         2013/05/07	Revision History         Revision Description         Prepared         Date           0         ECN-1305063         NEW SPEC         XIAOXIONG         2013/05/07	Revision History         Revision Description         Prepared         Date           0         ECN-1305063         NEW SPEC         XIAOXIONG         2013/05/07	Revision History  Rev. ECN # Revision Description Prepared	PAGE: <b>3</b> OF <b>9</b>
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#### TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR

#### 2 SCOPE

This specification covers performance, tests and quality requirements for 0.50mm pitch BTB connector.

#### 3 APPLICABLE DOCUMENTS

**EIA-364: ELECTRONICS INDUSTRIES ASSOCIATION** 

#### 4 REQUIREMENTS

- 4.1 Design and Construction
  - 4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.
  - 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.
- 4.2 Materials and Finish
  - 4.2.1 Contact: High performance copper alloy (Phosphor Bronze)

Finish: (a) Contact Area: Refer to the drawing.

(b) Under plate: Refer to the drawing.

(c) Solder area: Refer to the drawing.

4.2.2 Housing: Thermoplastic High Temp., UL94V-0

#### 4.3 Ratings

- 4.3.1 Working Voltage Less than 36 Volts AC (per pin)
- 4.3.2 Voltage: 50 Volts AC (per pin)
- 4.3.3 Current: 0.5 Amperes (per pin)
- 4.3.4 Operating Temperature : -40°C to +80°C

Aces P/N:	50022	series
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#### TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR

#### 5 Performance

## 5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard					
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.					
ELECTRICAL							
Item	Requirement	Standard					
Low Level Contact Resistance	55 m Ω Max.(initial)per contact △R 10 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)					
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)					
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	300 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)					
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1,CONDITION1)					
	<b>MECHANICAL</b>						
Item	Requirement	Standard					
Durability	30 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min. (EIA-364-09)					
	Unit: Kg						
	Pins   Mating   Unmating   Force(Max)   Force(Min)   Initial   Final   Initial   Final	Operation Speed : 25.4 ± 3 mm/minute					
Mating / Unmating Forces	<20 2.0 1.0 0.2 0.2	Measure the force required to mate/unmate connector. (EIA-364-13)					
Contact Retention Force	0.2kgf MIN.	Operation Speed : 25.4 ± 3 mm/minute.					

#### Aces P/N: 50022 series TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR RELEASE DATE: 2014/01/18 REVISION: A ECN No: ECN-1401255 PAGE: **6** OF 9 Measure the contact retention force with tester. Operation Speed: Fitting Nail /Housing $25.4 \pm 3$ mm/minute. 0.2kgf MIN. Retention Force Measure the contact retention force with Tensile strength tester. The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. Vibration 1 µs Max. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I) Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three Shock (Mechanical) 1 µs Max. mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 100mA maximum for all contacts. (EIA-364-27, test condition A) ENVIRONMENTAL Item Requirement Standard Pre Heat : 150°C ~180°C. 60~120sec. Resistance to Reflow See Product Qualification and Test Heat : 230°C Min., 40sec Min. Soldering Heat Sequence Group 9 (Lead Free) Peak Temp. : 260°C Max, 10sec Max. Mate module and subject to follow condition for 5 cycles. See Product Qualification and Test 1 cycles: Thermal Shock Sequence Group 4 .55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I) Mated Connector 40°C, 90~95% RH, See Product Qualification and Test Humidity 96 hours. Sequence Group 4

Sequence Group 5

Temperature life

See Product Qualification and Test Subject mated connectors to

(EIA-364-31, Condition A, Method

temperature life at 85° for 96

## TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR

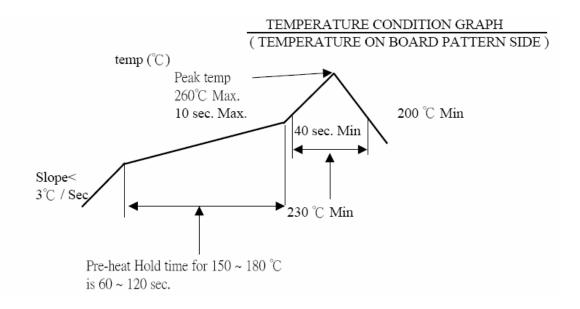
		hours. (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" or over 5 u"for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)

Note. Flowing Mixed Gas shell be conduct by customer request.

TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR

### 6 INFRARED REFLOW CONDITION

#### 6.1. Lead-free Process



TITLE: 0.5 MM PITCH BTB SMT S/T D/R CONNECTOR

### 7 PRODUCT QUALIFICATION AND TEST SEQUENCE

	Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	
				To	est Se	quenc	e			
Examination of Product				1 . 7	1 \ 6	1 \ 4			1	
Low Level Contact Resistance		1 ` 5	1 • 4	2、10	2、9	2、5			3	
Insulation Resistance				3 · 9	3、8					
Dielectric Withstanding Voltage				4 \ 8	4 \ 7					
Mating / Unmating Forces		2 · 4								
Temperature rise	1									
Durability		3								
Vibration			2							
Shock (Mechanical)			3							
Thermal Shock				5						
Humidity				6						
Temperature life					5					
Salt Spray						3				
Solder ability							1			
Terminal / Housing Retention Force								1		
Fitting Nail /Housing Retention Force								2		
Resistance to Soldering Heat									2	
Sample Size	2	4	4	4	4	4	2	4	4	